

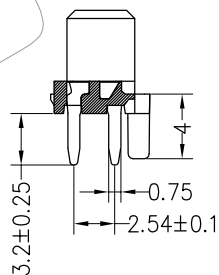
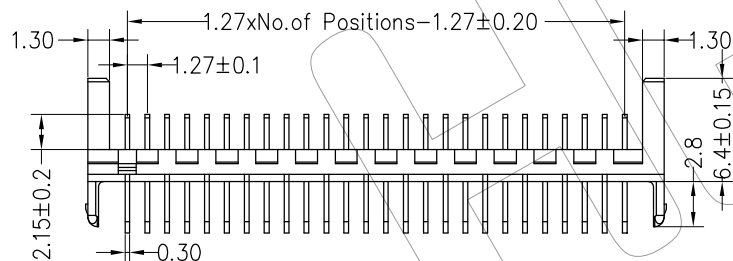
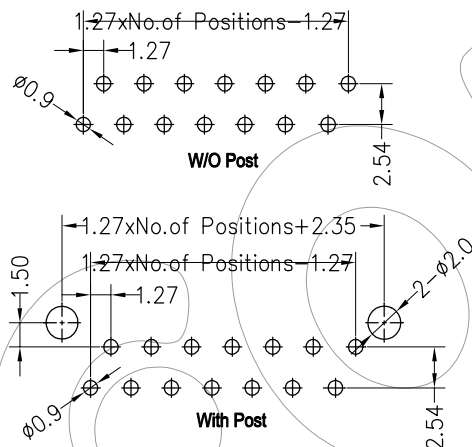
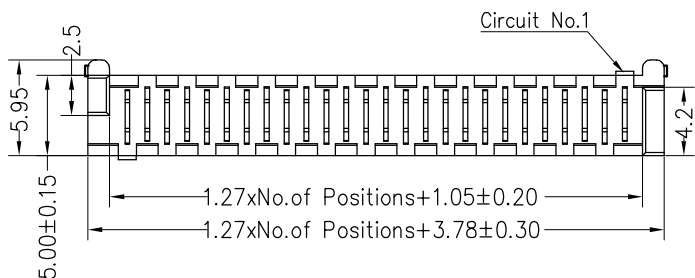
RoHS

Recommended P.C.B Layout(Top Side)
(PCB BOARD TOLERANCE ± 0.05)

SPECIFICATIONS

Rated Current:1.0AMP
Contact Resistance:20m Ω Max
Withstand Voltage:500V AC/DC
Insulation Resistance:1000M Ω Min
Operation Temperature:-40°C to +105°C

Contact Material:Phosphor Bronze
Contact Plating:Tin Plated
Insulator Material:Polyester(UL94V-0)
Standard: PA6T
Max.Processing Temp: 230°C for 30-60 seconds
(260°C for 10 seconds)



Ordering Information

HC-PX XX M S SM C X X 01

No. of Pins: 04~26P
Connector Type: S=Straight
Contact Plating: SN: Tin, SM: Matte-Tin
Post: W=With Post, N=W/O Post
Packing: T=Tube, R=Reel+Cap

OPERATION

X.X ± 0.30

X.XX ± 0.20

X.XXX ± 0.10

Angle $\pm 3^\circ$

DIM TOL

DRAW

Ayang

CHECK

APPROVE

SCALE

FIT

UNIT

mm

SIZE

A4

SHEET

1/1

PROJ.

ϕ ∇

HECON 东莞市禾康电子有限公司
DONGGUAN HECON ELECTRONICS CO.,LTD

PART NO.

HC-PXXXMSSMCXX01

TITLE:

1.27 Picoflex Header Connector DIP
(1.27IDC 公座DIP)

A0

REV

DATE

MODIFICATION DESCRIPTION

CHANGE

1

2

3

4

5

6

7

8

9